501777446 01/05/2012

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
Dan Shao	12/02/2011
Qingshan Hao	12/02/2011
Hongru Xu	12/02/2011

RECEIVING PARTY DATA

Name:	Giantec Semiconductor Ltd. Inc.		
Street Address:	No.12 Lane 647 Songtao Road		
Internal Address:	Zhangjiang Hi-Tech Park, Pudong New District		
City:	Shanghai		
State/Country:	CHINA		
Postal Code:	201203		

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	13310735	

CORRESPONDENCE DATA

 Fax Number:
 (810)592-5083

 Phone:
 6502796989

Email: jiang@apnethost.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via

US Mail.

Correspondent Name: Yuan Qing Jiang
Address Line 1: PO Box 61214

Address Line 4: Palo Alto, CALIFORNIA 94306

ATTORNEY DOCKET NUMBER: GT_2011_2_0

NAME OF SUBMITTER: Yuan Qing Jiang

Total Attachments: 1

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PATENT REEL: 027488 FRAME: 0785 13310735

CH \$40.00

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ASSIGNMENT OF PATENT APPLICATION

AGENT DOCKET NO. GT-2011-2-0

	*************	30000000000000000000000000000000000000	ML 1 100. 01-2011-2-0			
For good and valuable consideration, the	e receipt of	which is hereby acknowledged, I/We, the	ne undersigned,			
Shao, Dan; Hao, Qingshan; Xu,	Hongru					
who have created a certain invention for concurrently herewith and is entitled	which an a	application for United States Letters Pate	ent has been executed			
REVERSIBLE WRITE-PROTECTION FOR NON-VOLATILE SEMICONDUCTOR MEMORY DEVICE						
Filing date: 12/03/11 Application N	lo.: <u>13/3</u>	310,735				
Do hereby sell, assign and transfer to						
Giantec Semiconductor Ltd. Inc.		•	of Shanghai, China			
a company in the city of SHANGHAI ha	ving a plac	e of business at No.12 Lane 647 Songta	o Road,			
Zhangiiang Hi-Tech Park, Pudong New District. Shanghai 201203, China, its successors, assigns, and legal representatives the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may have be granted therefore in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filled in the United States, its territorial possessions and/or any foreign countries, and all rights together with all priority rights under any of the international conventions, unions, agreement, acts, and treaties;						
Agree that Giantec Semiconductor Ltd. I for said invention and said inventions, he territorial possessions and/or any foreign purpose of this assignment, at the expending undersigned will execute all continuation execute all rightful oaths, assignments, promunicate to said Assignee, its succeive relating to said invention and history there assigns and legal representatives shall or protection for said invention and for vestif Assignee, its successors, assigns and legal representatives.	ereinafter re countries; se of said s-in-part, co lower of att ssors, assi eof; and ge onsider de no title to s	eferred to as said invention, in its own national that, when requested to carry out in Assignee, its successors, assigns and le ontinuations, divisions, substitutes, reiss tomey and other parts, testify in any legatigns and legal representatives all facts killing and legal representatives all facts killing and legal representatives all facts killing in securing, maintaining that invention and all applications for patical pa	me, in the United States, its good faith the intent and gal representatives, the ues, extensions thereof, if or quasi legal proceedings; nown to the undersigned id Assignee, its successors, and enforcing proper patent			
Covenant with said Assignee, its success license or other agreement affecting the undersigned, and that full right to convey	rights and i	property herein conveyed has been mad	e to others by the			
I/we further authorize and direct authorized identified by the agent docket number and United States Patent and Trademark Office.	d title set f	o insert the serial number and filing date orth above as soon as the same shall ha	of said application now we been known to them by the			
IN TESTIMONY WHEREOF I have h	ereunto s	et MY signature on the date indicate	d below.			
Thero den	Date:	12/2/2011				
Shao, Dan						
Hao, Qingshan	Date:	12/2/2011				
Hergku Xu.	Date:	12/2/2011				

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